

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Makoto UEKI</td><td>08/31/2009</td></tr><tr><td>Takahiro ONODERA</td><td>08/31/2009</td></tr><tr><td>Yoshihiro HAYASHI</td><td>08/31/2009</td></tr></tbody></table>	Name	Execution Date	Makoto UEKI	08/31/2009	Takahiro ONODERA	08/31/2009	Yoshihiro HAYASHI	08/31/2009	
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Makoto UEKI	08/31/2009								
Takahiro ONODERA	08/31/2009								
Yoshihiro HAYASHI	08/31/2009								
RECEIVING PARTY DATA									
Name:	NEC Electronics Corporation								
Street Address:	1753 Shimonumabe, Nakahara-ku								
Internal Address:	Kawasaki								
City:	Kanagawa								
State/Country:	JAPAN								
Postal Code:	211-8668								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13302348</td></tr></tbody></table>	Property Type	Number	Application Number:	13302348					
Property Type	Number								
Application Number:	13302348								
CORRESPONDENCE DATA									
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NAME OF SUBMITTER:	Eric Jensen								
Total Attachments: 1 source=ASSMT#page1.tif									

OP \$40.00 13302348

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PATENT
REEL: 027268 FRAME: 0725

ASSIGNMENT

WHEREAS, MAKOTO UEKI, TAKAHIRO ONODERA and YOSHIHIRO HAYASHI
of Kanagawa, Japan

have invented certain new and useful improvements in SEMICONDUCTOR DEVICE HAVING
INSULATING FILM WITH SURFACE MODIFICATION LAYER AND METHOD FOR MANUFACTURING THE SAME
for which we are about to make application for Letters
(I/we have made—or am/are about to make)

Patent of the United States of America;

AND WHEREAS, NEC Electronics Corporation, 1753 Shimonumabe,
Nakahara-ku, Kawasaki, Kanagawa 211-8668, Japan is
desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the
United States;

NOW THEREFORE, be it known by all whom it may concern, that for and in consideration of
One Dollars (\$ 1.00)
to US in hand paid, the receipt of which is hereby acknowledged the said ASSIGNOR
have assigned, sold, and set over, and by these presents do hereby assign, sell, and set over unto the said
ASSIGNEE, NEC Electronics Corporation
* the full and exclusive right, title, and interest in and to the said invention,
as fully set forth and described in the:

Delete
inapplicable
wording

(a) specification prepared and executed by us on the 31st day of August, 2009,
(b) application filed on the _____ day of _____, _____, Serial No. _____,
preparatory to obtaining Letters Patent therefor; said invention, application and Letters Patent to be
held and enjoyed by the said ASSIGNEE, NEC Electronics Corporation
for their own use and behoof, and for their legal representatives, to the full end of the term
for which said Letters Patent are granted, as fully and entirely as the same would have been held by
us had this assignment and sale not been made.

IN TESTIMONY WHEREOF, we hereunto set our hands and affix our seals at
Kanagawa, Japan this 31st day of August, A.D. 2009

Witness:

Makoto Ueki
(Inventor's full Signature) MAKOTO UEKI

Takahiro Onodera
TAKAHIRO ONODERA

Yoshihiro Hayashi
YOSHIHIRO HAYASHI